

PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT4445216

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
SIH-HAN LI	04/28/2017
SHYH-SHYUAN SHEU	04/28/2017
YA-WEN YANG	04/28/2017
CHIH-PING CHENG	04/28/2017
CHIH-SHENG LIN	04/28/2017
RECEIVING PARTY DATA	
Name:	INDUSTRIAL TECHNOLOGY RESEARCH INSTITUTE
Street Address:	NO. 195, SEC. 4, CHUNG HSING RD., CHUTUNG
City:	HSINCHU
State/Country:	TAIWAN
Postal Code:	31040
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	15607389
CORRESPONDENCE DATA	
Fax Number:	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Email:	naquintero@quinterolaw.com
Correspondent Name:	NELSON QUINTERO
Address Line 1:	615 HAMPTON DRIVE SUITE A202
Address Line 4:	VENICE, CALIFORNIA 90291
ATTORNEY DOCKET NUMBER:	10140392
NAME OF SUBMITTER:	NELSON A. QUINTERO
SIGNATURE:	/Nelson A. Quintero/
DATE SIGNED:	06/05/2017
Total Attachments: 2	
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ASSIGNMENT

WHEREAS, Sih-Han LI, Shyh-Shyuan SHEU, Ya-Wen YANG, Chih-Ping CHENG and Chih-Sheng LIN hereafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: SENSOR INTERFACE CIRCUIT AND SENSOR OUTPUT ADJUSTING METHOD
Filed: _____ Serial No. _____
Executed on: 2017/4/28

WHEREAS, Industrial Technology Research Institute of No. 195, Sec. 4, Chung Hsing Rd., Chutung, Hsinchu 31040, Taiwan, R. O. C. hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same;

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.

Full name of sole or first inventor: Sih-Han LI	
Inventor's signature: Sih-Han LI	Date: 2017.4.28

Full name of second inventor: Shyh-Shyuan SHEU	
Inventor's signature: Shyh-Shyuan SHEU	Date: 2017.4.28

Full name of third inventor: Ya-Wen YANG	
Inventor's signature: Ya-Wen YANG	Date: 2017, 4, 28

Full name of fourth inventor: Chih-Ping CHENG	
Inventor's signature: Chih-Ping CHENG	Date: 2017, 4, 28

Full name of fifth inventor: Chih-Sheng LIN	
Inventor's signature: Chih-Sheng LIN	Date: 2017, 4, 28